

AOW418-VB Datasheet N-Channel 100-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)			
100	0.0085 at V _{GS} = 10 V	100			
	0.010 at V _{GS} = 6 V	85			

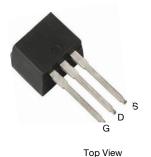
FEATURES

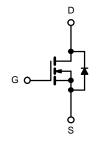
TrenchFET[®] Power MOSFET
175 °C Maximum Junction Temperature

Compliant to RoHS Directive 2002/95/EC



TO-262





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \degree C$, unless otherwise noted						
Parameter			Limit	Unit		
Drain-Source Voltage			100	N/		
Gate-Source Voltage			± 20	V		
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	I _D	100			
	T _C = 125 °C	'D	75 ^a	^		
Pulsed Drain Current	I _{DM}	300	A			
Avalanche Current	L = 0.1 mH	I _{AS}	75			
Single Pulse Avalanche Energy ^b	L = 0.1 IIIA	E _{AS}	280	mJ		
Maximum Power Dissipation ^b	T_{C} = 25 °C (TO-220AB and TO-263)	PD	250 ^c	w		
	T _A = 25 °C (TO-263) ^d	۰D	3.75	vv		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Limit	Unit		
Junction-to-Ambient	PCB Mount (TO-263) ^d	- R _{thJA}	40			
Junction-to-Ambient	Free Air (TO-220AB)		62.5	°C/W		
Junction-to-Case		R _{thJC}	0.6			

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	Symbol		IVIIII.	Typ.	Max.	Unit	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	100				
Gate-Threshold Voltage		$V_{GS} = V_{GS}, I_D = 250 \mu A$	100		3	V	
5	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu \text{A}$ $V_{DS} = 0 \text{V}, V_{GS} = \pm 20 \text{V}$	1		-	~ ^	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$ $V_{DS} = 100 V, V_{GS} = 0 V$			± 100	nA	
					1	_	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			50	μΑ	
		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$			250	 	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			A	
		V _{GS} = 10 V, I _D = 30 A		0.0085		- - Ω -	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		0.010			
	DO(01)	V_{GS} = 10 V, I_{D} = 30 A, T_{J} = 125 °C		0.017			
		V_{GS} = 10 V, I_{D} = 30 A, T_{J} = 175 °C		0.022			
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	25			S	
Dynamic ^b							
Input Capacitance	C _{iss}			6550		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = 25 V$, f = 1 MHz		665			
Reverse Transfer Capacitance	C _{rss}	7		265			
Total Gate Charge ^c	Qg			105	160		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 85 \text{ A}$		17		nC	
Gate-Drain Charge ^c	Q _{gd}	1		23			
Turn-On Delay Time ^c	t _{d(on)}			12	25		
Rise Time ^c	t _r	V _{DD} = 50 V, R _I = 0.6 Ω		90	135	ns	
Turn-Off DelayTime ^c	t _{d(off)}	$I_D \cong 85 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 2.5 \Omega$		55	85		
Fall Time ^c	t _f	-		130	195	1	
Source-Drain Diode Ratings and Chai	racteristics T _C	= 25 °C ^b					
Continuous Current	Is				85		
Pulsed Current	I _{SM}				240	A	
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}	г / Go -		85	140	ns	
Peak Reverse Recovery Current		I _F = 50 A, dl/dt = 100 A/μs		4.5	7	A	
r can rieverse riecovery Current	I _{RM(REC)}	$F = 00.70, 0.000 = 100.70 \mu 3$		4.5	'	μC	

Notes:

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55 °C

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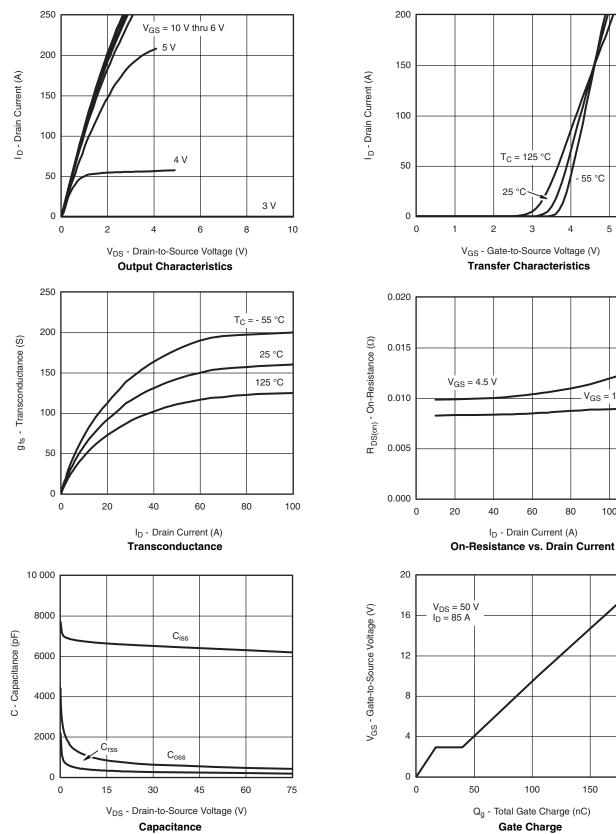
V_{GS} = 10 V

100

120

6

TYPICAL CHARACTERISTICS $T_A = 25 \text{ °C}$, unless otherwise noted

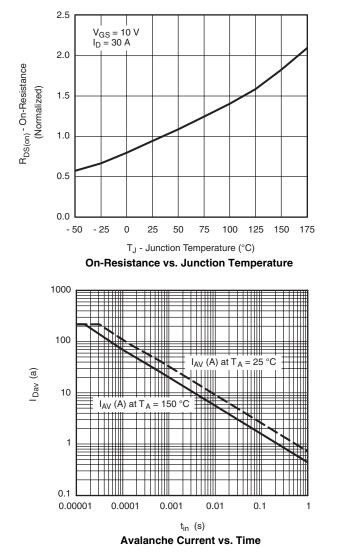


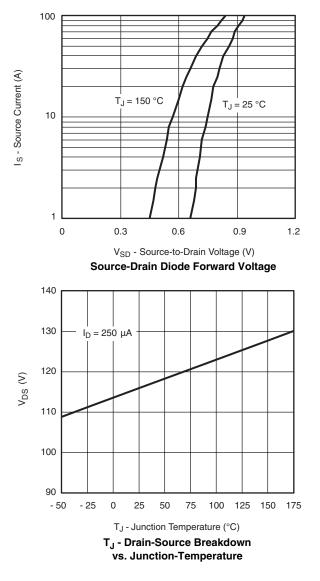
200

150



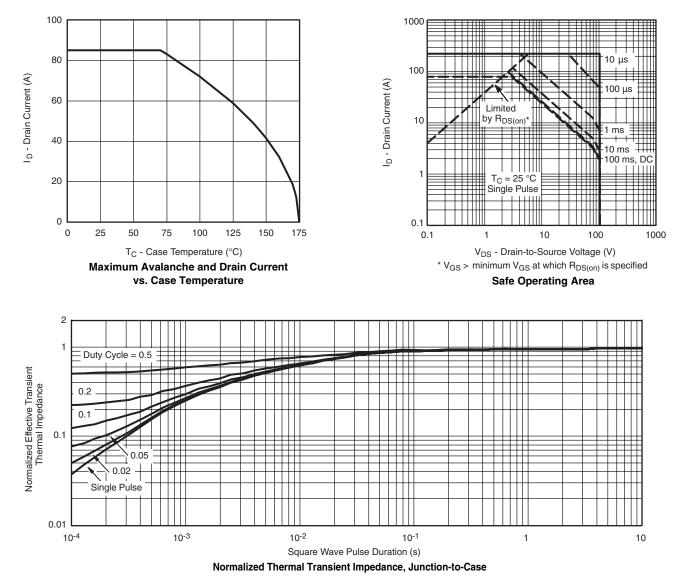
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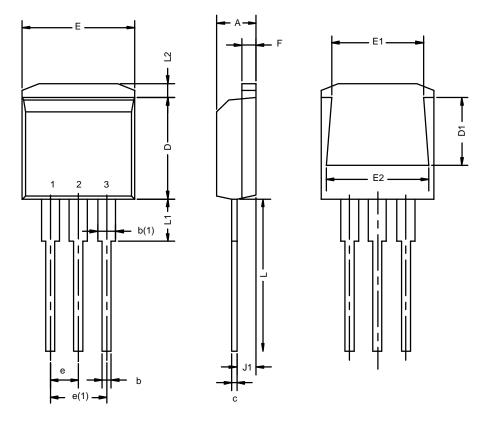


THERMAL RATINGS





TO-262: 3-LEAD



	MILLIM	ETERS*	INCHES		
Dim	Min	Max	Min	Max	
Α	4.32	4.70	0.170	0.185	
b	0.64	1.00	0.025	0.039	
b(1)	1.14	1.40	0.045	0.055	
C	0.36	0.50	0.014	0.020	
D	8.64	9.65	0.340	0.380	
D1	5.59	6.10	0.220	0.240	
е	2.41	2.67	0.095	0.105	
e(1)	4.95	5.33	0.195	0.210	
E	10.03	10.41	0.395	0.410	
E1	7.87	8.64	0.310	0.340	
E2	9.02	9.53	0.355	0.375	
F	1.14	1.40	0.045	0.055	
J1	2.41	2.79	0.095	0.110	
L	13.08	14.22	0.515	0.560	
L1	-	3.81	-	0.150	
L2	1.02	1.40	0.040	0.055	
ECN: T-02234—Rev. C, 14-Oct-02 DWG: 5855					

*Use millimeters as the primary measurement



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